

Features

- Wide Single-supply Voltage Range or Dual Supplies: +2.5 V to +36 V or ± 1.25 V to ± 18 V
- Very Low Supply Current (150 μ A/ch)
- Low Input Bias Current: 1 nA maximum
- Low Offset Voltage: ± 6.0 mV maximum
- Input Common-mode Voltage Range Includes Ground
- Internal Differential Input Voltage Range Equal to The Supply Voltage
- Low Output Saturation
- -40°C to 125°C Operation Range
- ESD Rating: HBM 4 kV, CDM 2 kV

Applications

- High-speed Line or Digital Line Receivers
- High Speed Sampling Circuits
- Peak and Zero-crossing Detectors
- Threshold Detectors/Discriminators
- Sensing at Ground or Supply Line

Description

The devices in this series consist of dual/ quad independent single or dual supply voltage comparators on a single monolithic substrate. The common mode input voltage range includes ground even when operated from a single supply, and the low power supply current drain makes these comparators suitable for battery operation. These types were designed to directly interface with TTL and CMOS. Current drain is independent of the supply voltage. The outputs can be connected to other open-collector outputs to achieve wired-AND relationships.

All devices are specified for the temperature range of -40°C to 125°C .

Typical Application Circuit

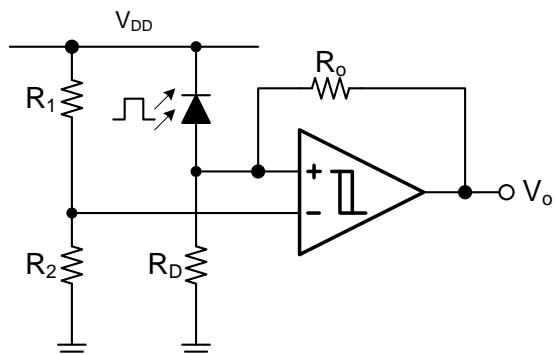


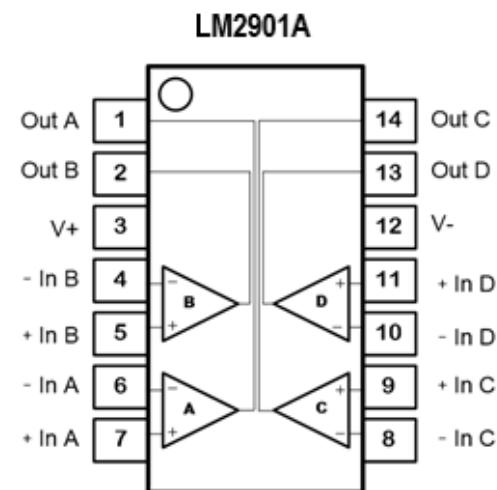
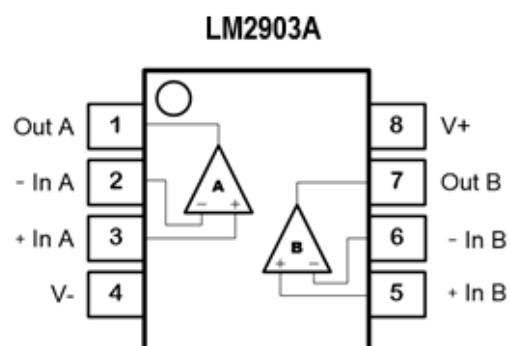
Table of Contents

| | |
|---|-----------|
| Features | 1 |
| Applications | 1 |
| Description | 1 |
| Typical Application Circuit..... | 1 |
| Revision History | 3 |
| Pin Configuration..... | 4 |
| Specifications | 5 |
| Absolute Maximum Ratings ⁽¹⁾ | 5 |
| ESD, Electrostatic Discharge Protection | 5 |
| Thermal Information | 5 |
| Electrical Characteristics | 6 |
| Typical Performance Characteristics | 7 |
| Application and Implementation | 8 |
| Application Information | 8 |
| Typical Application | 9 |
| Tape and Reel Information..... | 10 |
| Package Outline Dimensions | 11 |
| SOP8 | 11 |
| MSOP8 | 12 |
| SOP14 | 13 |
| TSSOP14 | 14 |
| Order Information | 15 |
| IMPORTANT NOTICE AND DISCLAIMER..... | 16 |

Revision History

| Date | Revision | Notes |
|------------|----------|--|
| 2022-05-05 | Rev.A.0 | <p>Update new document format.</p> <p>Update package outline dimensions with 3PEAK new POD format, no change on the product.</p> <p>Combine LM2903A, LM2901A to one datasheet.</p> <p>Updated I_{OS}, I_B, I_{DIFF} spec:</p> <ul style="list-style-type: none"> I_B: add max limit value 1nA at 25 °C, add max limit value 10nA at -40°C to 125°C I_{OS}: add max limit value 1nA at 25 °C, add max limit value 10nA at -40°C to 125°C I_{OS}: add typical value 50nA at 25 °C |
| 2022-05-13 | Rev.A.1 | <p>Correct typo error in order information:</p> <p>MSL of LM2903AL1-SR: "3" -> "1", no change on the product.</p> |
| 2023-05-29 | Rev.A.2 | <p>The following updates are all about the new datasheet formats or typo, the actual product remains unchanged.</p> <p>Updated symbol of Figure 3 in Typical Performance Characteristics.</p> <p>Updated address of web site.</p> <p>Updated tape and reel information.</p> |

Pin Configuration



Specifications

Absolute Maximum Ratings ⁽¹⁾

| Parameter | | Min | Max | Unit |
|-----------|--|-------------|-------------|------|
| | Supply Voltage: $V^+ - V^-$ | | 42 | V |
| | Input Voltage | $V^- - 0.3$ | $V^+ + 0.3$ | V |
| | Input Current: $+IN, -IN$ ⁽²⁾ | -20 | +20 | mA |
| | Output Current: OUT | -20 | +20 | mA |
| | Output Short-Circuit Duration ⁽³⁾ | | Infinite | |
| | Current at Supply Pins | -60 | +60 | mA |
| T_J | Maximum Junction Temperature | | 150 | °C |
| T_A | Operating Temperature Range | -40 | 125 | °C |
| T_{STG} | Storage Temperature Range | -65 | 150 | °C |
| T_L | Lead Temperature (Soldering 10 sec) | | 260 | °C |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

(2) The inputs are protected by ESD protection diodes to each power supply. If the input extends more than 500 mV beyond the power supply, the input current should be limited to less than 10 mA.

(3) A heat sink may be required to keep the junction temperature below the absolute maximum. This depends on the power supply voltage and how many amplifiers are shorted. Thermal resistance varies with the amount of PC board metal connected to the package. The specified values are for short traces connected to the leads.

ESD, Electrostatic Discharge Protection

| Symbol | Parameter | Condition | Minimum Level | Unit |
|--------|--------------------------|---------------------------------------|---------------|------|
| HBM | Human Body Model ESD | ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | 4 | kV |
| CDM | Charged Device Model ESD | ANSI/ESDA/JEDEC JS-002 ⁽²⁾ | 2 | kV |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

Thermal Information

| Package Type | θ_{JA} | θ_{JC} | Unit |
|--------------|---------------|---------------|------|
| SOP8 | 158 | 43 | °C/W |
| MSOP8 | 210 | 45 | °C/W |
| SOP14 | 97 | 47 | °C/W |
| TSSOP14 | 108 | 43 | °C/W |

Electrical Characteristics

All test condition is $V_{CC} = 5\text{ V}$, $R_{PU} = 10\text{ k}\Omega$, $C_L = 15\text{ pF}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|------------|---|--|---------------------------------------|-----|-----------|----------------|------|
| V_{CC} | Supply Voltage | $T_A = -40^\circ\text{C}$ to 125°C | | 2.5 | | 36 | V |
| V_{OS} | Input Offset Voltage | $V_{CC} = 5\text{ V}$ to 30 V , $V_{CM} = 0\text{ V}$, $V_O = 1.4\text{ V}$, $T_A = -40^\circ\text{C}$ to 125°C | | -6 | ± 0.6 | +6 | mV |
| I_B | Input Bias Current ⁽¹⁾ | $V_{DM} = 0\text{ V}$, $V_{CM} = 0\text{ V}$ | | | 0.1 | 1 | nA |
| | | $V_{DM} = 0\text{ V}$, $V_{CM} = 0\text{ V}$, $T_A = -40^\circ\text{C}$ to 125°C | | | 1 | 10 | nA |
| I_{OS} | Input Offset Current ⁽¹⁾ | $V_{DM} = 0\text{ V}$, $V_{CM} = 0\text{ V}$ | | | 0.1 | 1 | nA |
| | | $V_{DM} = 0\text{ V}$, $V_{CM} = 0\text{ V}$, $T_A = -40^\circ\text{C}$ to 125°C | | | 1 | 10 | nA |
| I_{Diff} | Input Differential Current | $V_{CC} = 36\text{ V}$, $V_{DM} = 36\text{ V}$ | | | 50 | | nA |
| C_{IN} | Input Capacitance | $T_A = 25^\circ\text{C}$ | Differential | | 2.5 | | pF |
| | | | Common Mode | | 5 | | |
| V_{CM} | Common-mode Input Voltage Range | | | 0 | | $V_{CC} - 1.5$ | V |
| | | $T_A = -40^\circ\text{C}$ to 125°C | | 0 | | $V_{CC} - 2$ | V |
| A_{VD} | Large-signal Differential-voltage Amplification | $V_{CC} = 15\text{ V}$, $V_O = 1.4\text{ V}$ to 11.4 V , $R_L \geq 15\text{ k}\Omega$ to V_{CC} | | 50 | 400 | | V/mV |
| I_{OH} | High-level Output Current | $V_{OH} = 5\text{ V}$, $V_{ID} = 1\text{ V}$ | | | 25 | 200 | nA |
| | | $V_{CC} = 36\text{ V}$, $V_{OH} = 36\text{ V}$, $V_{ID} = 1\text{ V}$, $T_A = -40^\circ\text{C}$ to 125°C | | | | 7 | µA |
| V_{OL} | Low-Level Output Voltage | $I_{OL} = 4\text{ mA}$, $V_{ID} = -1\text{ V}$ | | | 250 | 400 | mV |
| | | $I_{OL} = 4\text{ mA}$, $V_{ID} = -1\text{ V}$, $T_A = -40^\circ\text{C}$ to 125°C | | | | 500 | mV |
| I_{OL} | Low-Level Output Current | $V_{OL} = 1.5\text{ V}$, $V_{ID} = -1\text{ V}$ | | 10 | | | mA |
| I_Q | Quiescent Current per Comparator | $V_{CC} = 5\text{ V}$ | | | 150 | 300 | µA |
| | | $V_{CC} = 36\text{ V}$ | | | 150 | 300 | µA |
| t_{RT} | Response Time | R_L connected to 5 V through $5.1\text{ k}\Omega$, $C_L = 15\text{ pF}$ | 100-mV input step with 5-mV overdrive | | 2 | | µs |
| | | | TTL-level input step | | 0.5 | | |

(1) Provided by bench test and design simulation

Typical Performance Characteristics

All test conditions: $V_s = 5 \text{ V}$, $V_{CM} = 0 \text{ V}$, $R_L = \text{Open}$, unless otherwise noted.

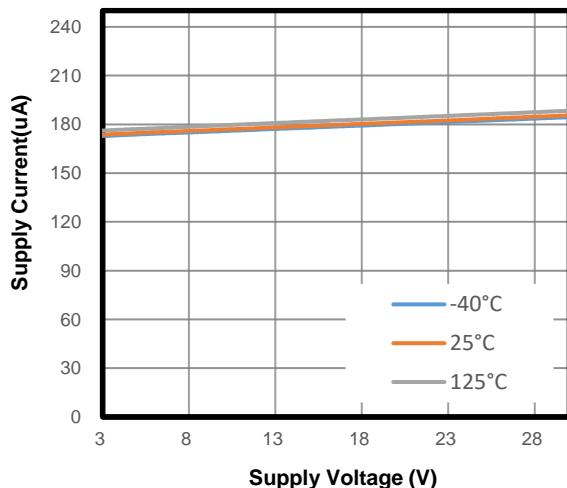


Figure 1. Supply Current vs. Supply Voltage (Dual Channel)

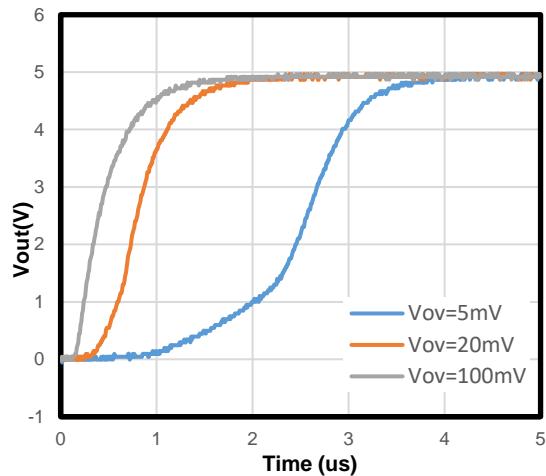


Figure 2. Response Time for Various Input Overdrives: Positive Transition

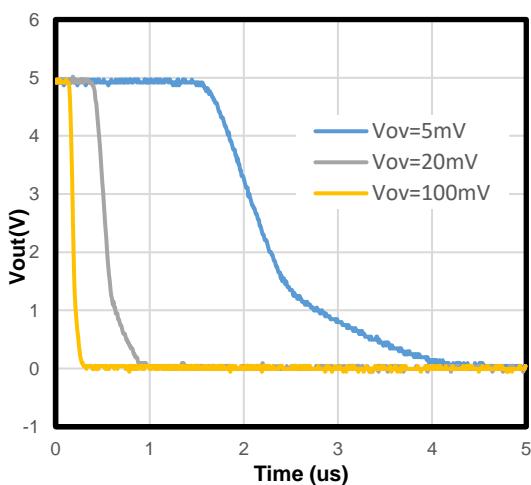


Figure 3. Response Time for Various Input Overdrives: Negative Transition

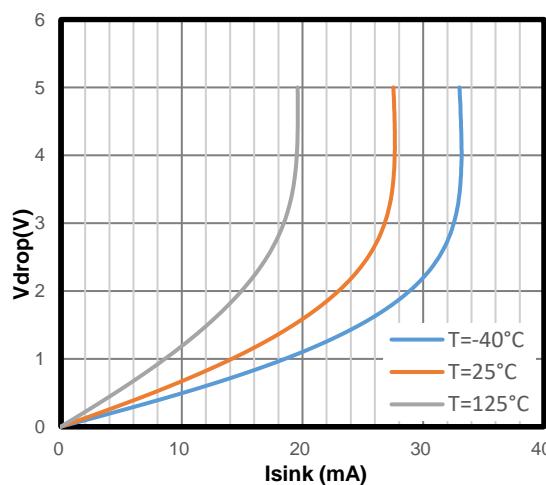


Figure 4 Negative Output Swing vs. Sink Current

Application and Implementation

NOTE

Information in the following applications sections is not part of the 3PEAK's component specification and 3PEAK does not warrant its accuracy or completeness. 3PEAK's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

Application Information

Power Supply Layout and Bypass

The LM2903A/2901A family's power supply pin should have a local bypass capacitor (i.e., 0.01 μF to 0.1 μF) within 2mm for good high frequency performance. It can also use a bulk capacitor (i.e., 1 μF or larger) within 100mm to provide large, slow currents. This bulk capacitor can be shared with other analog parts.

Good ground layout improves performance by decreasing the amount of stray capacitance and noise at the comparator's inputs and outputs. To decrease stray capacitance, minimize PCB lengths and resistor leads, and place external components as close to the comparator' pins as possible.

Inputs

The electrostatic discharge (ESD) protection input structure of two back-to-back diodes and 1k Ω series resistors are used to limit the differential input voltage applied to the precision input of the comparator by clamping input voltages that exceed supply voltages, as shown in Figure 5. Large voltage exceeding the supply voltage should be avoided to prevent damage to the input stage.

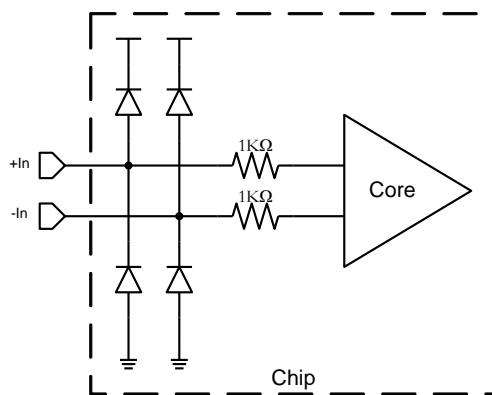


Figure 5 Equivalent Input Structure

Operation Outside of the Common Input Voltage Range

The following is a list of input voltage situation and their outcomes:

1. When both IN- and IN+ are both within the common-mode range:
 - 1) If IN- is higher than IN+ and the offset voltage, the output is low and the output MOSFET is sinking Current.
 - 2) If IN- is lower than IN+ and the offset voltage, the output is high impedance.
2. When IN- is higher than common-mode and IN+ is within common-mode, the output is low and the output MOSFET is sinking current.
3. When IN+ is higher than common-mode and IN- is within common-mode, the output is high impedance.
4. When IN- and IN+ are both higher than common-mode, the output is in uncertain state.

Typical Application

IR Receiver

The device is an ideal candidate to be used as an infrared receiver shown in Figure 6. The infrared photo diode creates a current relative to the amount of infrared light present. The current creates a voltage across RD. When this voltage level cross the voltage applied by the voltage divider to the inverting input, the output transitions. Optional Ro provides additional hysteresis for noise immunity.

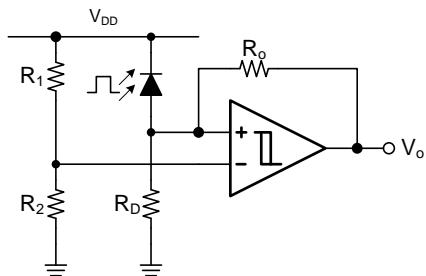
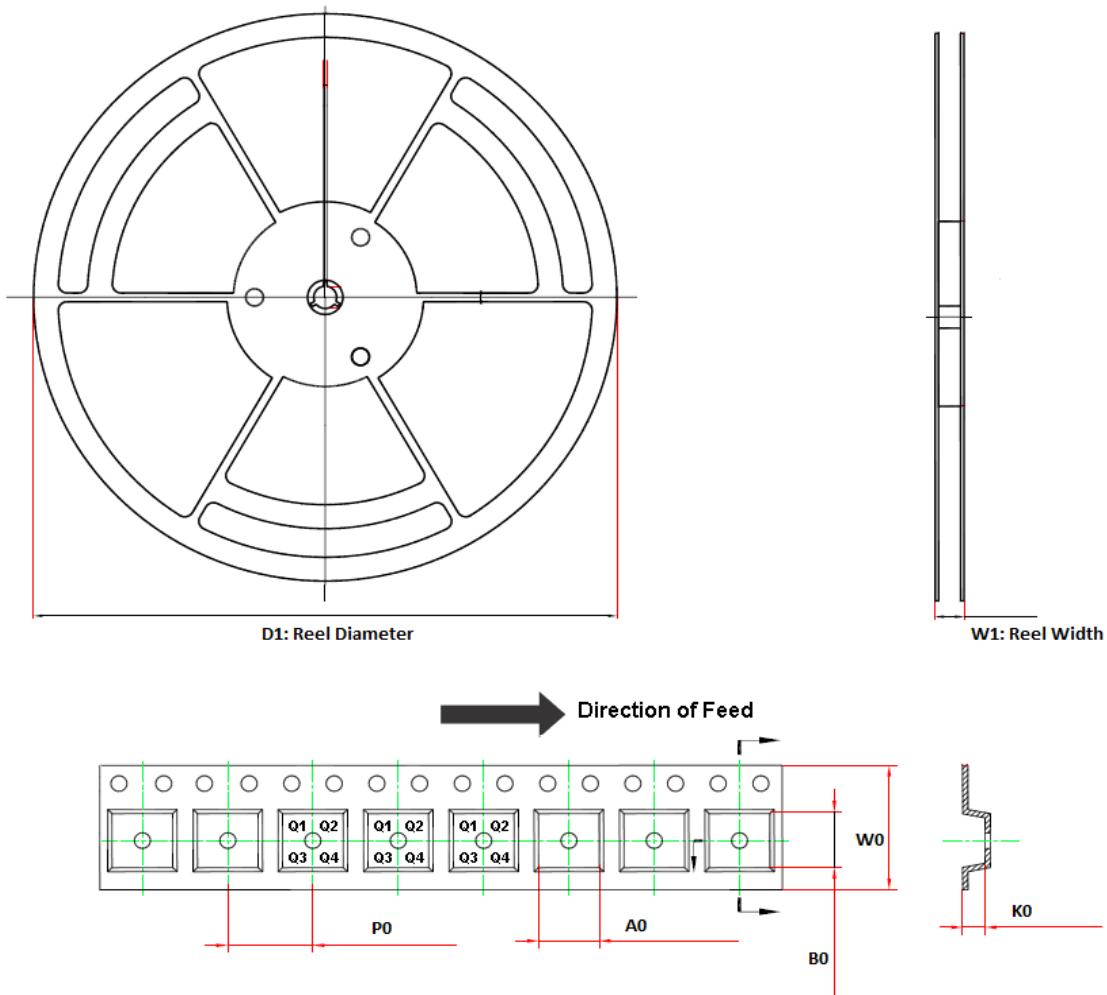


Figure 6. IR Receiver

Tape and Reel Information



| Order Number | Package | D1 (mm) | W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P0 (mm) | W0 (mm) | Pin1 Quadrant |
|--------------|---------|------------|------------|------------|------------|------------|------------|------------|------------------|
| LM2903A-SR | SOP8 | 330.0 | 17.6 | 6.5 | 5.4 | 2.0 | 8.0 | 12.0 | Q1 |
| LM2903AL1-SR | SOP8 | 330.0 | 17.6 | 6.5 | 5.4 | 2.0 | 8.0 | 12.0 | Q1 |
| LM2903A-VR | MSOP8 | 330.0 | 17.6 | 5.2 | 3.3 | 1.5 | 8.0 | 12.0 | Q1 |
| LM2901A-SR | SOP14 | 330.0 | 21.6 | 6.5 | 9.2 | 2.0 | 8.0 | 16.0 | Q1 |
| LM2901A-TR | TSSOP14 | 330.0 | 17.6 | 6.8 | 5.4 | 1.7 | 8.0 | 12.0 | Q1 |

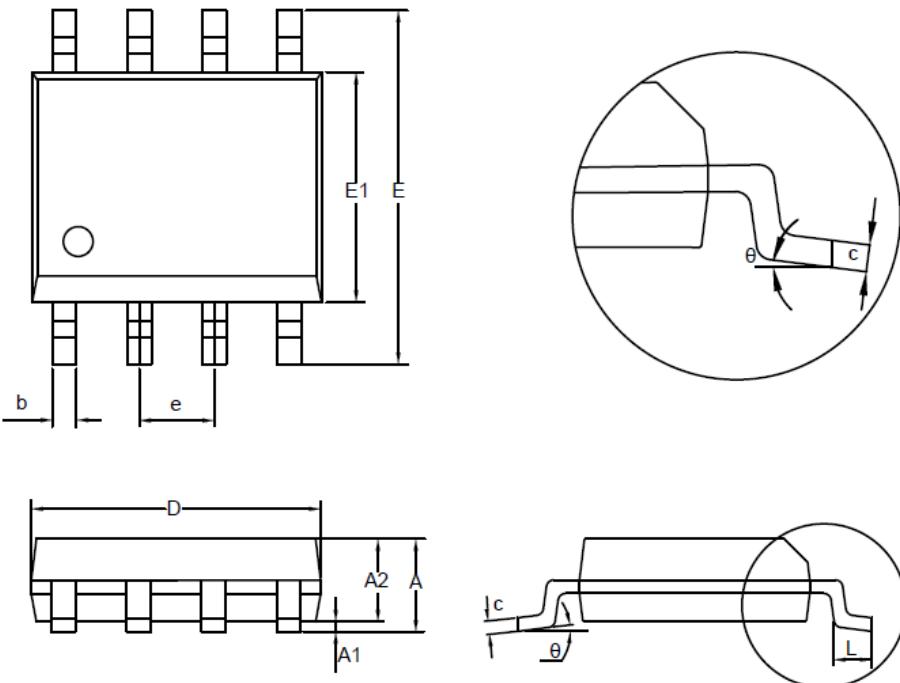
Package Outline Dimensions

SOP8

| Package Outline Dimensions | | SO1(SOP-8-A) | | | |
|----------------------------|---------------------------|--------------|----------------------|-------|--|
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
| | MIN | MAX | MIN | MAX | |
| A | 1.350 | 1.750 | 0.053 | 0.069 | |
| A1 | 0.050 | 0.250 | 0.002 | 0.010 | |
| A2 | 1.250 | 1.550 | 0.049 | 0.061 | |
| b | 0.330 | 0.510 | 0.013 | 0.020 | |
| c | 0.170 | 0.250 | 0.007 | 0.010 | |
| D | 4.700 | 5.100 | 0.185 | 0.201 | |
| E | 5.800 | 6.200 | 0.228 | 0.244 | |
| E1 | 3.800 | 4.000 | 0.150 | 0.157 | |
| e | 1.270 BSC | | 0.050 BSC | | |
| L | 0.400 | 1.000 | 0.016 | 0.039 | |
| θ | 0 | 8° | 0 | 8° | |

NOTES

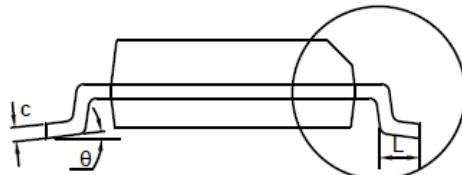
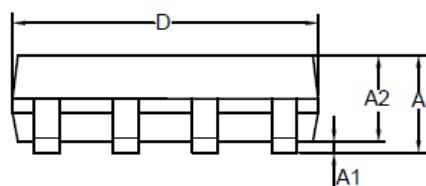
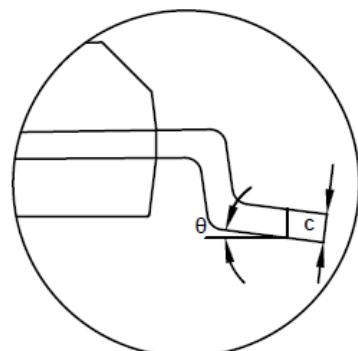
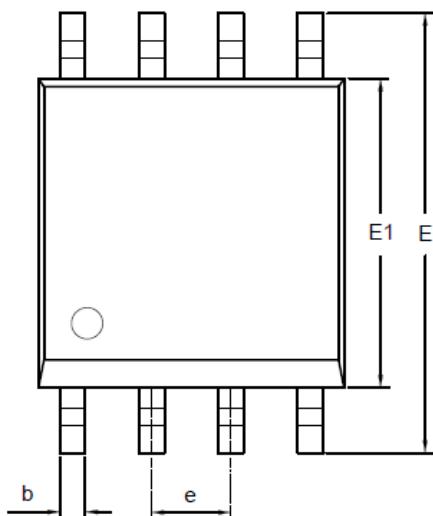
1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.



MSOP8

Package Outline Dimensions

VS1(MSOP-8-A)



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.800 | 1.100 | 0.031 | 0.043 |
| A1 | 0.050 | 0.150 | 0.002 | 0.006 |
| A2 | 0.750 | 0.950 | 0.030 | 0.037 |
| b | 0.250 | 0.380 | 0.010 | 0.015 |
| c | 0.090 | 0.230 | 0.004 | 0.009 |
| D | 2.900 | 3.100 | 0.114 | 0.122 |
| E | 4.700 | 5.100 | 0.185 | 0.201 |
| E1 | 2.900 | 3.100 | 0.114 | 0.122 |
| e | 0.650 BSC | | 0.026 BSC | |
| L | 0.400 | 0.800 | 0.016 | 0.031 |
| θ | 0 | 8 | 0 | 8 |

NOTES

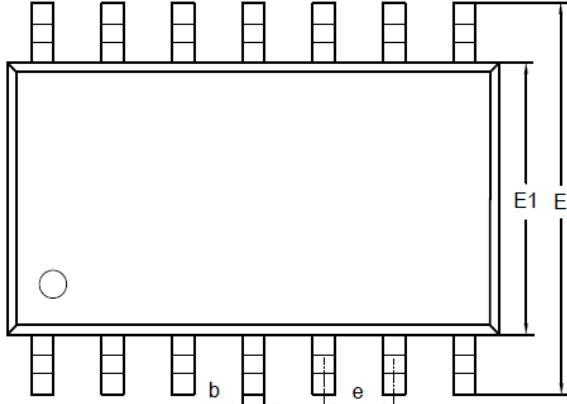
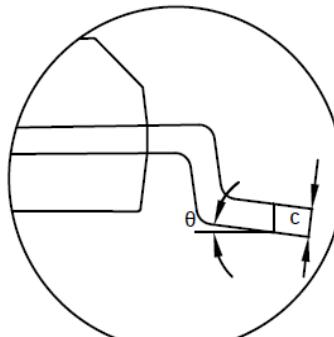
1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

SOP14

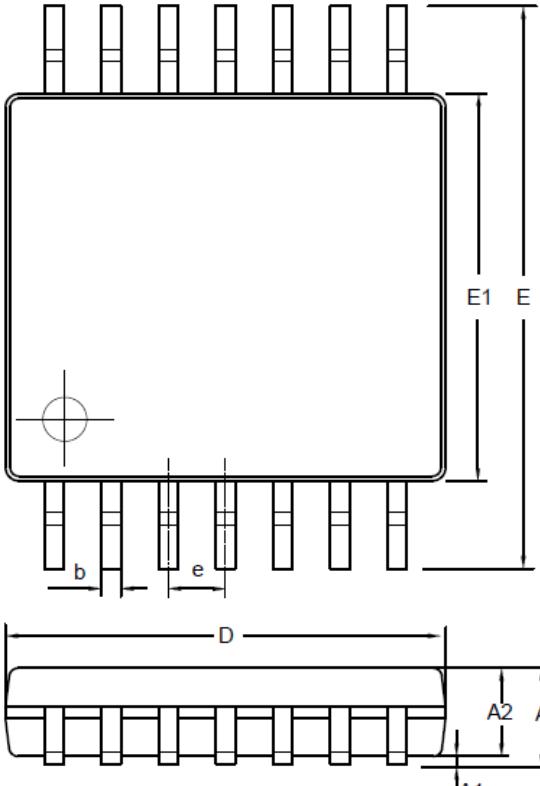
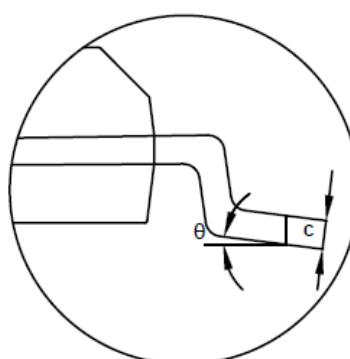
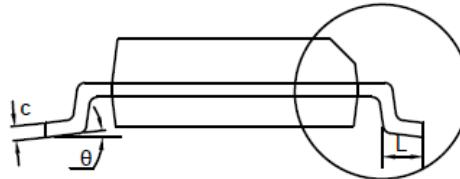
| Package Outline Dimensions | | SO2(SOP-14-A) | | | |
|----------------------------|------------------------------|---------------|-------------------------|-------|--|
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
| | MIN | MAX | MIN | MAX | |
| A | 1.350 | 1.750 | 0.053 | 0.069 | |
| A1 | 0.050 | 0.250 | 0.002 | 0.010 | |
| A2 | 1.250 | 1.650 | 0.049 | 0.065 | |
| b | 0.310 | 0.510 | 0.012 | 0.020 | |
| c | 0.100 | 0.250 | 0.004 | 0.010 | |
| D | 8.450 | 8.850 | 0.333 | 0.348 | |
| E | 5.800 | 6.200 | 0.228 | 0.244 | |
| E1 | 3.800 | 4.000 | 0.150 | 0.157 | |
| e | 1.270 BSC | | 0.050 BSC | | |
| L | 0.400 | 1.270 | 0.016 | 0.050 | |
| θ | 0 | 8° | 0 | 8° | |

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

TSSOP14

| Package Outline Dimensions | | TS2(TSSOP-14-A) | | | |
|--|---------------------------|--|----------------------|-------|--|
|  | |  | | | |
|  | | | | | |
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
| | MIN | MAX | MIN | MAX | |
| A | 0.900 | 1.200 | 0.035 | 0.047 | |
| A1 | 0.050 | 0.150 | 0.002 | 0.006 | |
| A2 | 0.800 | 1.050 | 0.031 | 0.041 | |
| b | 0.190 | 0.300 | 0.007 | 0.012 | |
| c | 0.090 | 0.200 | 0.004 | 0.008 | |
| D | 4.900 | 5.100 | 0.193 | 0.201 | |
| E | 6.200 | 6.600 | 0.244 | 0.260 | |
| E1 | 4.300 | 4.500 | 0.169 | 0.177 | |
| e | 0.650 BSC | | 0.026 BSC | | |
| L | 0.450 | 0.750 | 0.018 | 0.030 | |
| θ | 0 | 8° | 0 | 8° | |

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

Order Information

| Order Number | Operating Temperature Range | Package | Marking Information | MSL | Transport Media, Quantity | Eco Plan |
|---------------------------|-----------------------------|---------|---------------------|-----|---------------------------|----------|
| LM2903AL1-SR | -40 to 125°C | SOP8 | 2903A | 1 | Tape and Reel, 4000 | Green |
| LM2903A-SR | -40 to 125°C | SOP8 | LM393 | 3 | Tape and Reel, 4000 | Green |
| LM2903A-VR | -40 to 125°C | MSOP8 | 2903A | 3 | Tape and Reel, 3000 | Green |
| LM2901A-SR | -40 to 125°C | SOP14 | 2901A | 3 | Tape and Reel, 2500 | Green |
| LM2901A-TR ⁽¹⁾ | -40 to 125°C | TSSOP14 | 2901A | 3 | Tape and Reel, 3000 | Green |

(1) Future product, contact 3PEAK factory for more information and sample.

Green: 3PEAK defines "Green" to mean RoHS compatible and free of halogen substances.

IMPORTANT NOTICE AND DISCLAIMER

Copyright© 3PEAK 2012-2023. All rights reserved.

Trademarks. Any of the 思瑞浦 or 3PEAK trade names, trademarks, graphic marks, and domain names contained in this document /material are the property of 3PEAK. You may NOT reproduce, modify, publish, transmit or distribute any Trademark without the prior written consent of 3PEAK.

Performance Information. Performance tests or performance range contained in this document/material are either results of design simulation or actual tests conducted under designated testing environment. Any variation in testing environment or simulation environment, including but not limited to testing method, testing process or testing temperature, may affect actual performance of the product.

Disclaimer. 3PEAK provides technical and reliability data (including data sheets), design resources (including reference designs), application or other design recommendations, networking tools, security information and other resources "As Is". 3PEAK makes no warranty as to the absence of defects, and makes no warranties of any kind, express or implied, including without limitation, implied warranties as to merchantability, fitness for a particular purpose or non-infringement of any third-party's intellectual property rights. Unless otherwise specified in writing, products supplied by 3PEAK are not designed to be used in any life-threatening scenarios, including critical medical applications, automotive safety-critical systems, aviation, aerospace, or any situations where failure could result in bodily harm, loss of life, or significant property damage. 3PEAK disclaims all liability for any such unauthorized use.